

Leading Thermal Analysis -

Thermal Resistance and Effective Thermal Conductivity Measurements of Thermal Grease Using the Flash Diffusivity Method

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Introduction

- Reliable performance measurements of thermal grease and other thermal interface materials used in electronics packaging are important for material selection and design validation.
- With thin layers typically 10's of microns, measurements can be difficult with various steady-state thermal conductivity methods.
- Utilizing multilayer analysis and special sample holders, the flash diffusivity method is well-suited to measurements of interfacial resistance and effective thermal conductivity of thin interfaces.
- Materials including grease, phase-change, filled epoxy, filled elastomeric pads can be tested in a "sandwich" configuration.

Flash Diffusivity Method: Measurement Principle Introduced by Parker et al. 1961

Thermal diffusivity is a measure of how quickly a material can change its temperature

The front surface of a plane-parallel sample is heated by a single short light or laser pulse.

The temperature rise on the rear surface is measured versus time using an IR detector.



Method - Introduction

Thermal conductivity can be derived by combining measurements of thermal diffusivity, specific heat and density

$$\lambda(T) = \alpha(T) \cdot c_p(T) \cdot \rho(T)$$





3 layer: film – substrate sandwich

sample holder for application of clamping pressure

Thermal Interface Materials – Sandwich Method



R_{th} thermal resistance (mm²-K/W)

 ΔT temperature difference (K)

Q heat flow (W)

A area (mm²)

- R_{con} contact thermal resistance (mm²-K/W)
- ΔT_{int} interface temperature difference (K)
- R_{tot} total gap thermal resistance (mm²-K/W)
- λ_{eff} effective thermal conductivity (W/m-K)

$$\lambda_{eff} = rac{\Delta x}{R_{tot}} = rac{\Delta x}{rac{\Delta x}{\lambda} + 2(R_{con})}$$

		Pro	operties at 25°C		
		ρ (g/cm ³)	С _р (J/g-К)	λ (W/m-K)	
Dow Corning® 340	silicone based, ZnO filler	2.10	0.80	0.67 (datasheet)	
Arctic Silver® 5	non-silicone, Ag, Al ₂ O ₃ and BN fillers	4.05	0.60	n.a.	
Al alloy substrates	12.7 mm x 2 mm	2.70	0.90	139	

Instrument

Netzsch LFA 467 (xenon flash source, InSb IR detector, 400 μ s pulse width)



Dow Corning® 340 Properties at 25°C



		Dow Corning® 340 Properties at 25°C			
Gap ∆x (mm)	λ _{eff} (W/m-K)	R _{tot} (mm²-K/W)			
0.136	0.682	199		bulk λ (1/slope): 2(R) (v-intercept):	
0.104	0.650	160			
0.076	0.59	128			
0.049	0.56	88			
0.035	0.54	65			
0.023	0.49	47			
0.013	0.39	34			
0.005	0.22	23			



Arctic Silver® 5 Properties at 25°C



		Arctic Silver® Properties at 2
Gap ∆x	λ_{eff}	R_{tot}
(mm)	(W/m-K)	(mm²-K/VV)
0.141	1.21	116
0.099	1.15	86
0.057	1.08	53
0.032	0.98	33
0.018	0.81	22
0.011	0.64	17
0.007	0.56	13
0.004	0.45	9.0

Conclusions

- The flash diffusivity method is well-suited to measurements of thermal resistance and effective thermal conductivity for thin interfacial layers.
- With three-layer "sandwich" measurements over a range of gap thickness, contact thermal resistance and bulk thermal conductivity can be estimated.
- Measurements of two commercially available thermal greases showed significant differences in bulk thermal conductivity and contact resistance.

Thank you for your attention!



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